

**RESPONSE UNDER 37 C.F.R. § 1.116
EXPEDITING PROCEDURE
EXAMINING GROUP 1700**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: *Chen, et al.*

Docket No.: TSM6283131RI

Serial No.: 10/650,886

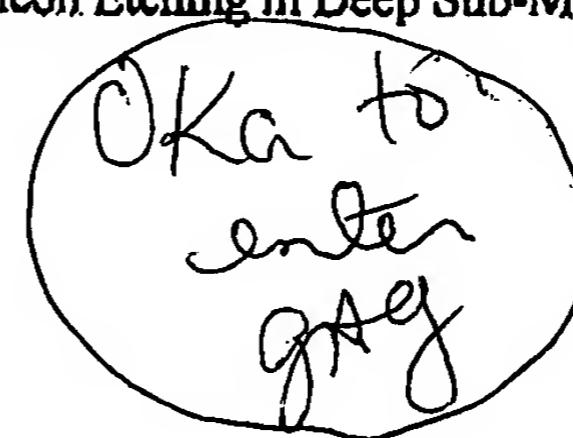
Art Unit: 1763

Filed: August 28, 2003

Examiner: George A. Goudreau

For: In-Situ Strip Process for Polysilicon Etching in Deep Sub-Micron
Technology

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450



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RESPONSE TO FINAL OFFICE ACTION UNDER 37 CFR § 1.116

Dear Sir:

Applicant respectfully submits the following amendment and remarks in response to the Final Office Action dated February 18, 2005. Applicant respectfully requests that this amendment and remarks be entered pursuant to the provisions of 37 CFR § 1.116, as it is believed that this amendment is fully responsive to Examiner's rejections and places the application in condition for allowance.

TSM6283131RI

Page 1 of 13